



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	BFP 620F H7764	<b>Issued</b>	10. May 2021
<b>MA#</b>	MA001613022		
<b>Package</b>	PG-TSFP-4-1	<b>Weight*</b>	1.87 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	tin	7440-31-5	0.001	0.03		269	
	noble metal	gold	7440-57-5	0.002	0.10		1041	
	inorganic material	silicon	7440-21-3	0.017	0.90	1.03	8987	10297
leadframe	inorganic material	silicon	7440-21-3	0.000	0.01		79	
	non noble metal	titanium	7440-32-6	0.001	0.04		395	
	non noble metal	chromium	7440-47-3	0.002	0.12		1184	
	non noble metal	copper	7440-50-8	0.734	39.30	39.47	393035	394693
wire	noble metal	gold	7440-57-5	0.007	0.36	0.36	3613	3613
encapsulation	organic material	carbon black	1333-86-4	0.010	0.52		5170	
	plastics	epoxy resin	-	0.208	11.12		111156	
	inorganic material	silicondioxide	60676-86-0	0.749	40.06	51.70	400679	517005
leadfinish	non noble metal	tin	7440-31-5	0.049	2.62	2.62	26200	26200
plating	noble metal	silver	7440-22-4	0.090	4.82	4.82	48192	48192
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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